



SANYO Semiconductors

DATA SHEET

LB11669M — Monolithic Digital IC For Fan Motor Two-Phase Half-Wave Driver

Overview

The LB11669M is a two-phase uni-polar brushless motor driver for fan motor.

Functions

- Two-phase half-wave drive.
- RD (lock detection) outputs incorporated.
- FG (rotation detection) outputs incorporated.
- Thermal shutdown circuit incorporated.
- Lock protection and automatic return function incorporated.
- Output protection zener diode incorporated.
- Hall input amplifier incorporated.

Specifications

Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum inflow current	$I_{IN\ max}$		100	mA
Output current	$I_{OUT\ ave}$		400	mA
	$I_{OUT\ peak}$	Only when starting and lock protection is activated	800	mA
Output withstand voltage	$V_{OUT\ max}$		Internal	V
FG/RD output current	$I_{FG/RD\ max}$		10	mA
FG/RD output withstand voltage	$V_{FG/RD\ max}$		30	V
Allowable power dissipation	$P_d\ max$	Mounted on a board *	800	mW
Operating temperature	T_{opr}		-30 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

* Specified board : 114.3mm × 76.1mm × 1.6mm, glass epoxy board.

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LB11669M

Recommended Operating Conditions at Ta = 25°C

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Parameter	Symbol	Conditions	Ratings	Unit
Inflow current range	I _{IN}		5 to 25	mA
Common-mode input voltage range	V _{COM}		0.2 to V _{IN} -2.3	V

Electrical Characteristics at Ta = 25°C, V_{CC}=24V, R₁=1kΩ, unless otherwise specified.

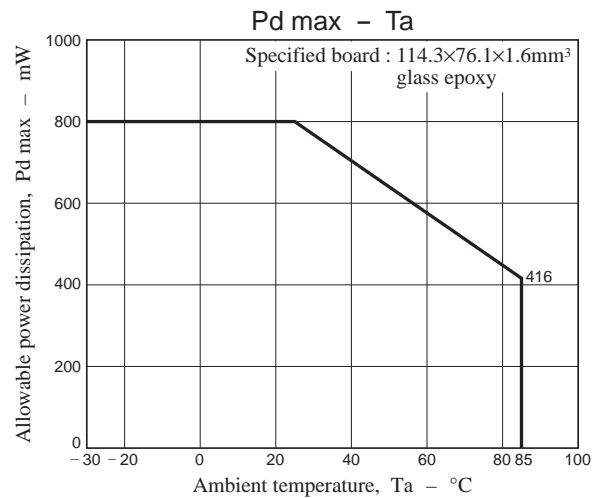
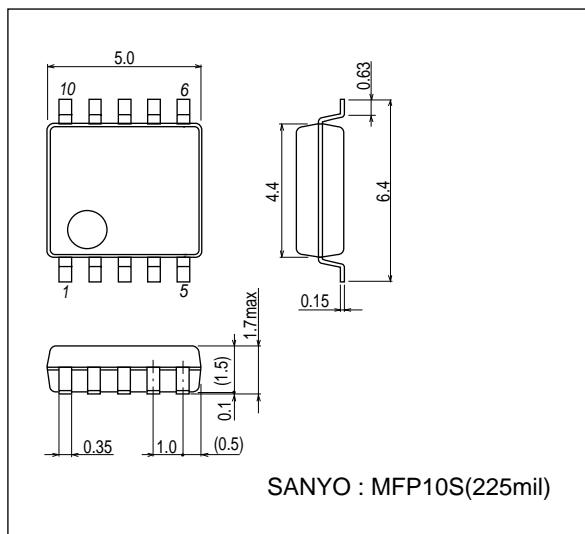
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
V _{IN} voltage	V _{IN}	I _{IN} = 6mA	5.95	6.3	6.65	V
CT capacitor charging current	I _{CT1}	CT = 0.5V	1.8	2.55	3.4	μA
CT capacitor dis-charging current	I _{CT2}	CT = 6.0V	0.15	0.23	0.31	μA
capacitor charging / dis-charging current ratio	R _{CT}	R _{CT} = I _{CT1} / I _{CT2}	10.5	11	14.5	
CT charging voltage	V _{CTH}	V _{CT} / V _{IN}	74	79	84	%
CT dis-charging voltage	V _{CTL}	V _{CT} / V _{IN}	41	46	51	%
Output limit withstand voltage	V _{OLM}	I _O = 100mA	49	52	55	V
Output saturation voltage	V _{OL1}	I _O = 200mA		0.85	1.1	V
Hall input sensitivity	V _{HN}	Including offset and hysteresis		±15	±30	mV
FG/RD output saturation voltage	V _{FG/RD}	I _{FG/RD} = 5mA		0.15	0.3	V
FG/RD output leak current	I _{FG/RDL}	V _{FG/RD} = 14V		0.1	10	μA
Thermal protection function operating temperature	TSD	Design target value *		180		°C

* Design target value and is not measured.

Package Dimensions

unit : mm (typ)

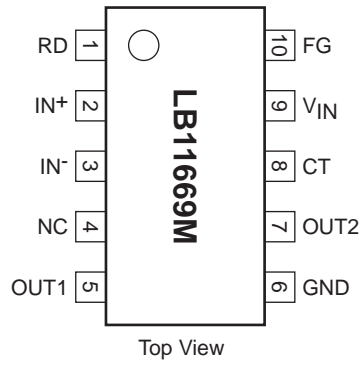
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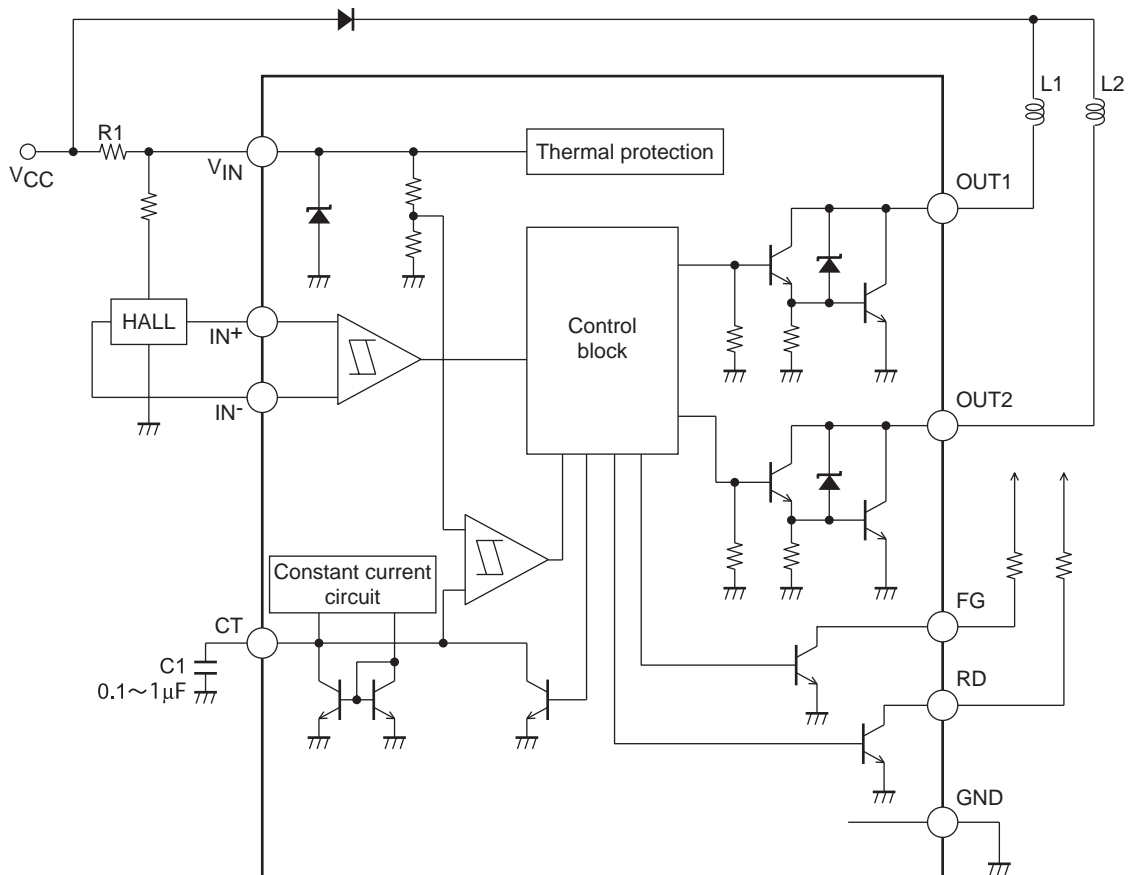
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Pin Assignment

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Block Diagram



Truth table

IN ⁻	IN ⁺	CT	OUT1	OUT2	FG	RD	Mode
H	L	L	H	L	L	L	Rotation
L	H		L	H	OFF	L	
H	L	H	OFF	OFF	L	OFF	Lock protection
L	H		OFF	OFF	OFF	OFF	

